

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1-11. (Canceled)

12. (Previously Presented) A multi-layer flexible wiring board comprising a first flexible wiring board and a second flexible wiring board connecting each other, wherein

the first flexible wiring board having:

a first resin film;

a first wiring film, a bottom face of which is embedded into the first resin film;

a second wiring film, a bottom face of which is in contact with a surface of the first resin film;

a second resin film formed on a surface of the first wiring film and a surface of the second wiring film, and

at least one first opening is formed in a part of the second resin film where the first wiring film is disposed,

at least one second opening is formed in a part of the second resin film where the second wiring film is disposed,

the second flexible wiring board comprises a base film, and a wire on the base film,

wherein a face of the second flexible wiring board at a side where the wire is disposed is located toward a face of the first flexible wiring board at a side where the second resin film is disposed,

a first bump is arranged in the first opening,

the wire of the second flexible wiring board is connected to the first wiring film by the first bump,

a second bump is arranged in the second opening,

the wire of the second flexible wiring board is connected to the second wiring film by the second bump.

13. (Original) A multi-layer flexible wiring board as claimed in claim 12, further comprising:

a third flexible wiring board having a base film, and a wire on the base film,

wherein a face of the third flexible wiring board at a side where the wire is disposed is located toward a face of the first flexible wiring board at a side where the first resin film is disposed,

at least one third opening is formed in a part of the first resin film where the first wiring film is disposed,

a third bump is arranged in the third opening,

the wire of the third flexible wiring board is connected to the first wiring film by the third bump.

14-21. (Canceled)